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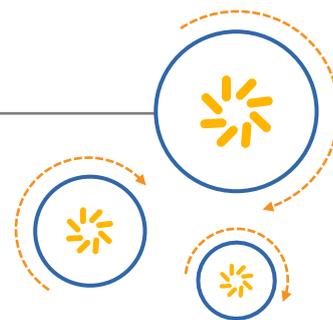
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RF360 Europe GmbH

A Qualcomm – TDK Joint Venture

SAW Components

SAW Duplexer

LTE Band 20

Series/type:	B8509
Ordering code:	B39851B8509P810
Date:	March 08, 2013
Version:	2.0

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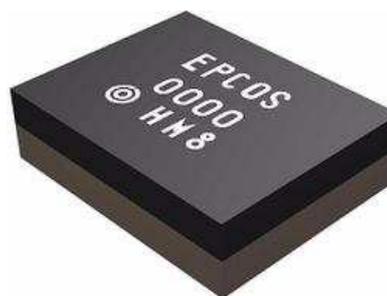
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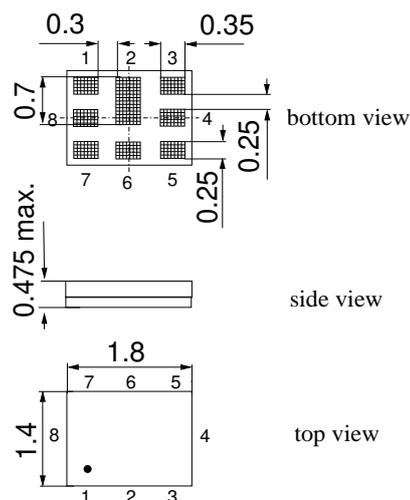
Data Sheet

Application

- Low-loss SAW duplexer for LTE Band 20 systems
- Very high isolation
- Usable passband 30 MHz
- Single-ended to balanced transformation in Antenna-Rx path
- Impedance transformation 50 Ω to 100 Ω in Antenna-Rx path
- Very small size and low height


Features

- Package size 1.8 * 1.4 mm²
- Maximum height : 0.475 mm
- RoHS compatible
- Package for **Surface Mount Technology (SMT)**
- Ni, Au-plated terminals
- **Electrostatic Sensitive Device (ESD)**
- **Moisture Sensitivity Level 3**


Pin configuration

- 3 Tx input
- 1, 8 Rx output (balanced)
- 6 Antenna
- 2, 4, 5, 7 To be grounded

Characteristics

Temperature range for specification:	T = -15 °C to +85 °C
TX terminating impedance:	Z _{Tx} = 50 Ω
ANT terminating impedance:	Z _{Ant} = 50 Ω 11 nH
RX terminating impedance:	Z _{Rx} = 100 Ω (balanced) 47 nH

Characteristics Tx-Antenna				min.	typ. @ 25 °C	max.	
Center frequency	f _c				847.0		MHz
Maximum insertion attenuation	α						
832.0 ... 862.0	MHz		-	2.2	2.8		dB
832.0 ... 862.0	MHz		-	2.2	2.5 ¹⁾		dB
Amplitude ripple (p-p)	Δα						
832.0 ... 862.0	MHz		-	1.2	1.9		dB
Input VSWR (Tx port)							
832.0 ... 862.0	MHz		-	1.6	2.0		
Output VSWR (Ant Port)							
832.0 ... 862.0	MHz		-	1.5	2.0		
Absolute attenuation	α						
10.0 ... 771.0	MHz		35	39	-		dB
771.0 ... 791.0	MHz		35	44	-		dB
791.0 ... 821.0	MHz		45	50	-		dB
873.0 ... 903.0	MHz		13	25	-		dB
925.0 ... 960.0	MHz		30	41	-		dB
1565.0 ... 1606.0	MHz		40	46	-		dB
1664.0 ... 2170.0	MHz		35	47	-		dB
2400.0 ... 2620.0	MHz		33	39	-		dB
2620.0 ... 2690.0	MHz		35	50	-		dB
3328.0 ... 3448.0	MHz		35	43	-		dB
4000.0 ... 6000.0	MHz		13	18	-		dB

¹⁾ in +25,+55 °C temperature range

Characteristics

Temperature range for specification:	T = -15 °C to +85 °C
TX terminating impedance:	Z _{Tx} = 50 Ω
ANT terminating impedance:	Z _{Ant} = 50 Ω 11 nH
RX terminating impedance:	Z _{Rx} = 100 Ω (balanced) 47 nH

Characteristics Antenna-Rx		min.	typ. @ 25 °C	max.	
Center frequency	f _c		806.0		MHz
Maximum insertion attenuation	α				
791.0 ... 821.0 MHz		-	2.4	3.5	dB
791.0 ... 821.0 MHz		-	2.4	3.0 ¹⁾	dB
Amplitude ripple (p-p)	Δα				
791.0 ... 821.0 MHz		-	1.2	2.5	dB
Input VSWR (Ant port)					
791.0 ... 821.0 MHz		-	1.6	2.0	
Output VSWR (Rx Port)					
791.0 ... 821.0 MHz		-	1.8	2.2	
Common mode rejection ratio					
791.0 ... 821.0 MHz		25	29	-	dB
Absolute attenuation	α				
10.0 ... 770.0 MHz		45	56	-	dB
770.0 ... 782.0 MHz		10	40	-	dB
832.0 ... 833.5 MHz		35	60	-	dB
833.5 ... 862.0 MHz		50	54	-	dB
873.0 ... 903.0 MHz		40	54	-	dB
1623.0 ... 1683.0 MHz		45	57	-	dB
2400.0 ... 2545.0 MHz		45	51	-	dB
2545.0 ... 4000.0 MHz		45	55	-	dB
4000.0 ... 6000.0 MHz		30	35	-	dB
Absolute mean attenuation	α _{mean}				
782.0 ... 790.0 MHz		4	8	-	dB
782.0 ... 790.0 MHz		6 ²⁾	8	-	dB

¹⁾ At +25 °C

²⁾ At +25 °C

Characteristics

Temperature range for specification:	T = -15 °C to +85 °C
TX terminating impedance:	Z _{Tx} = 50 Ω
ANT terminating impedance:	Z _{Ant} = 50 Ω 11 nH
RX terminating impedance:	Z _{Rx} = 100 Ω (balanced) 47 nH

Characteristics Tx-Rx	min.	typ. @ 25 °C	max.	
Differential mode isolation				α
791.0 ... 821.0 MHz	50	54	-	dB
832.0 ... 834.0 MHz	40	60	-	dB
834.0 ... 862.0 MHz	54	57	-	dB
1574.0 ... 1577.0 MHz	40	65	-	dB
1664.0 ... 1724.0 MHz	20	64	-	dB
2496.0 ... 2586.0 MHz	20	59	-	dB
Common mode isolation				α
832.0 ... 862.0 MHz	60	65	-	dB

Maximum Ratings

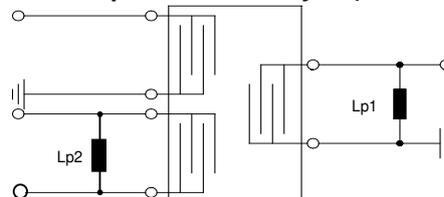
Storage temperature range	T _{stg}	-40/+85	°C	
DC voltage	V _{DC}	5 ¹⁾	V	
ESD voltage, Tx, Ant Port	V _{ESD}	100 ²⁾	V	MM Model
ESD voltage, Tx, Ant Port	V _{ESD}	300 ³⁾	V	HB Model
ESD voltage	V _{ESD}	500 ⁴⁾	V	CD Model
Input power at Tx Port				
832.0 ...862.0 MHz	P _{in}	27.5	dBm	} continuous wave 55 °C, 50000h
elsewhere	P _{in}	10	dBm	

1) 168h Damp Heat Steady State acc. to IEC60068-2-67 Cy

2) Acc. to FESD22-A115B (MM - Machine Model), 10 negative & 10 positive pulses

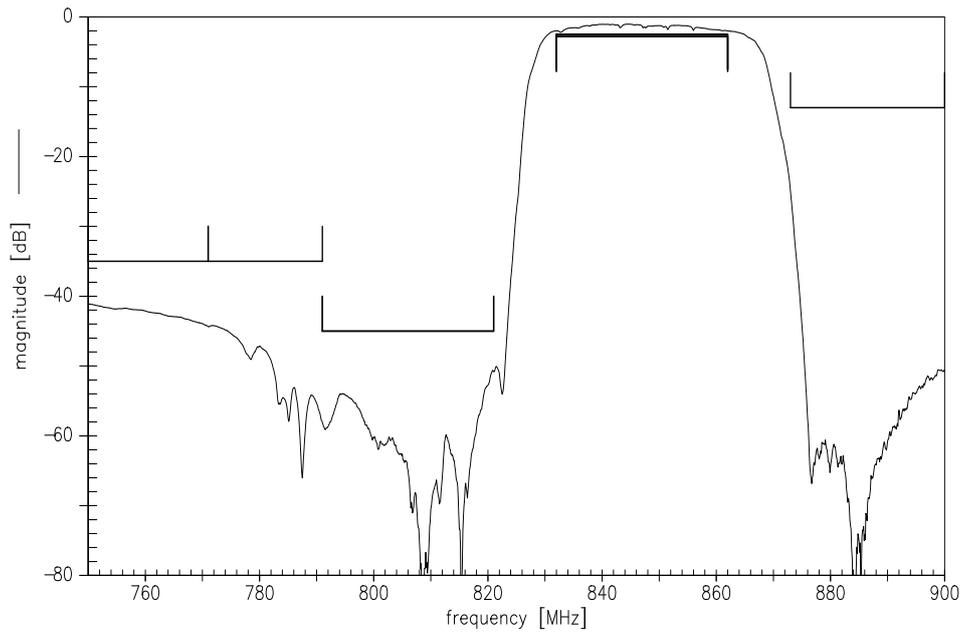
3) Acc. to JESD22-A114F (HBM - Human Body Level), 1 negative & 1 positive pulses.

4) Acc. to JESD22-C101C (CDM - Fiel Inducted Charged Device Model), 3 negative & 3 positive pulses.

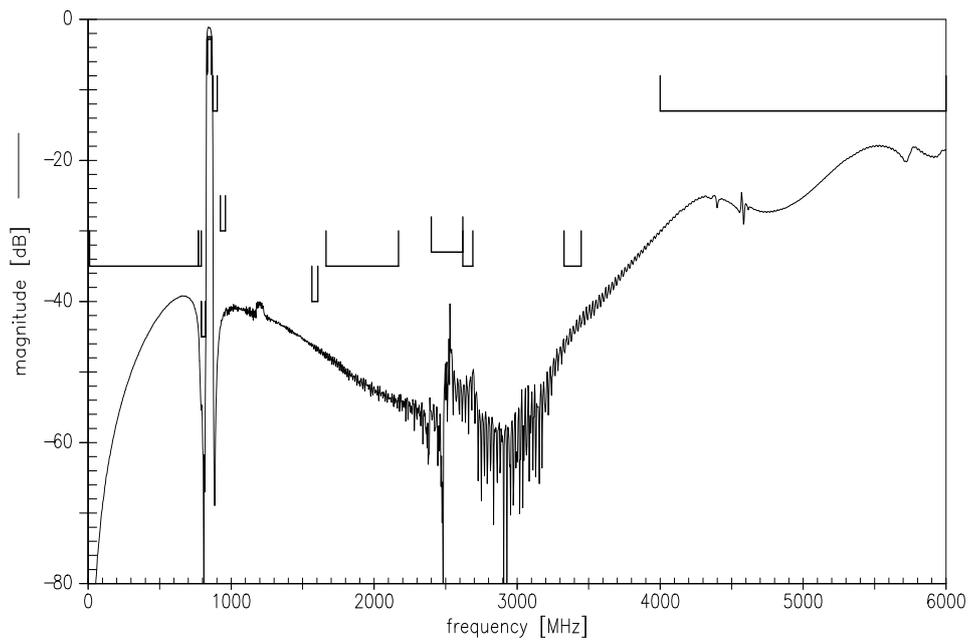
Matching network (element values depend on PCB layout)


Lp1=11nH, Lp2 =47nH

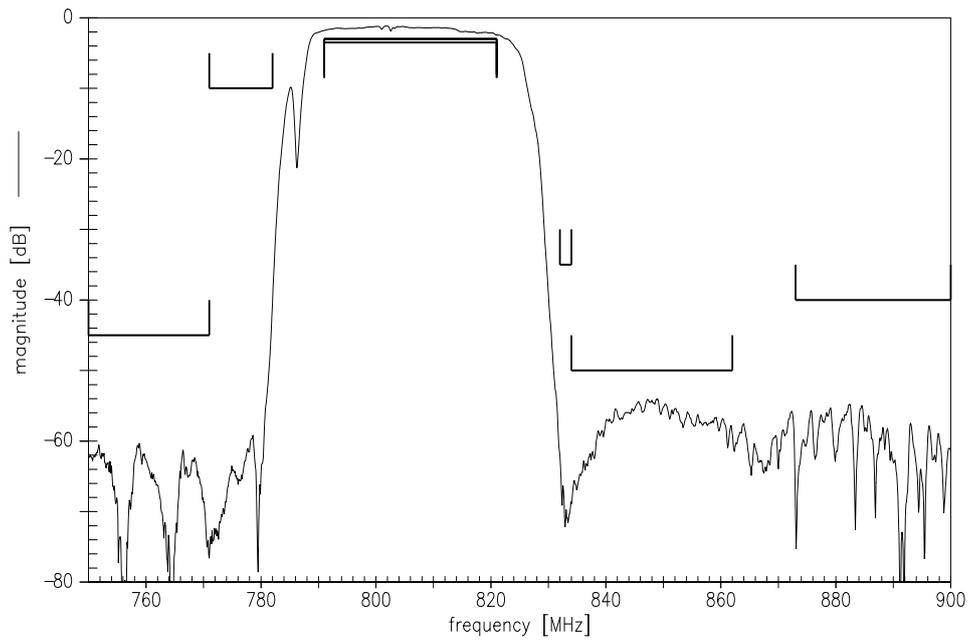
Frequency Response TX-ANT



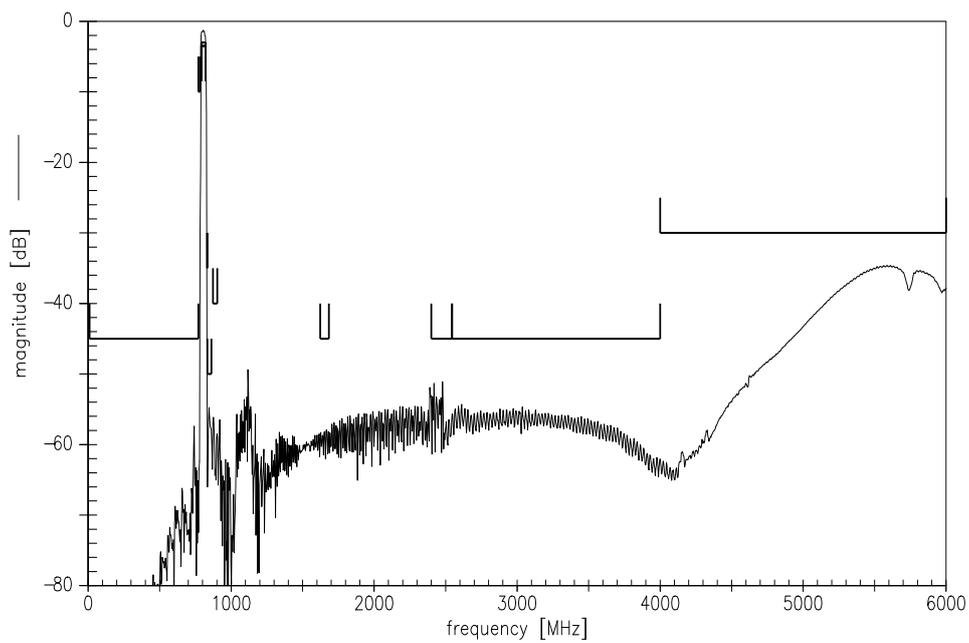
Frequency Response TX-ANT



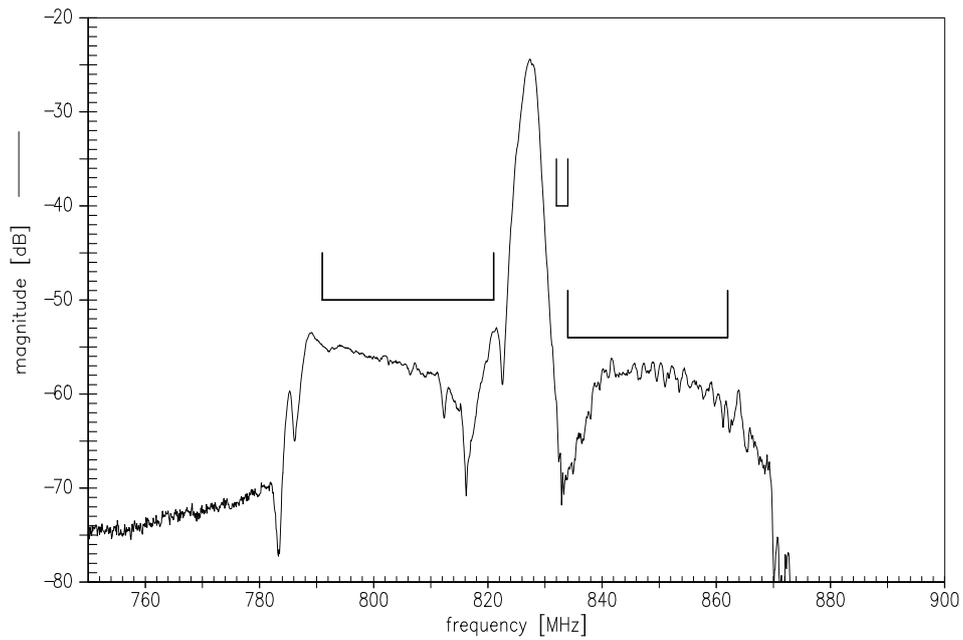
Frequency Response ANT-RX



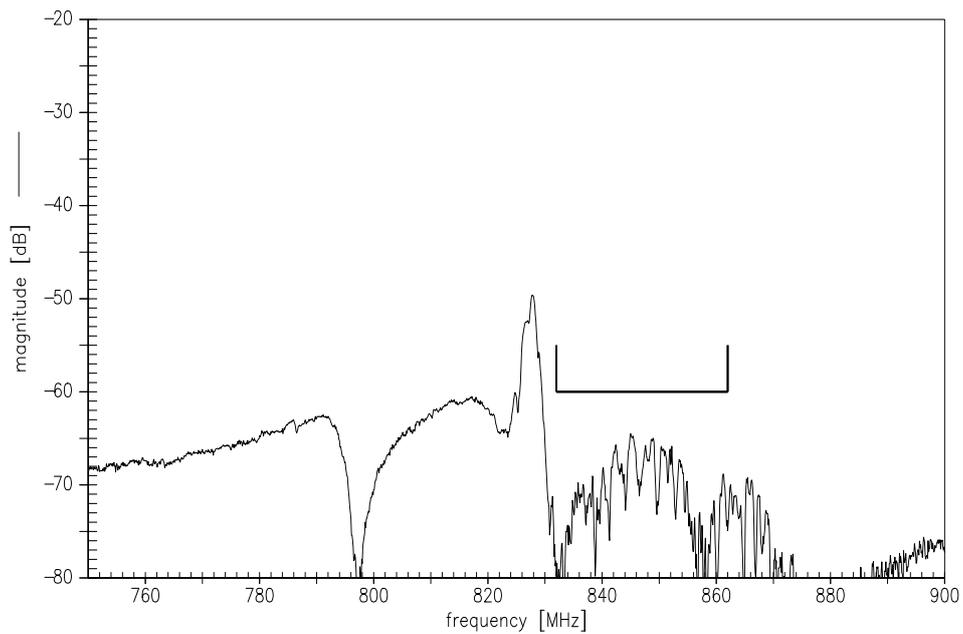
Frequency Response ANT-RX



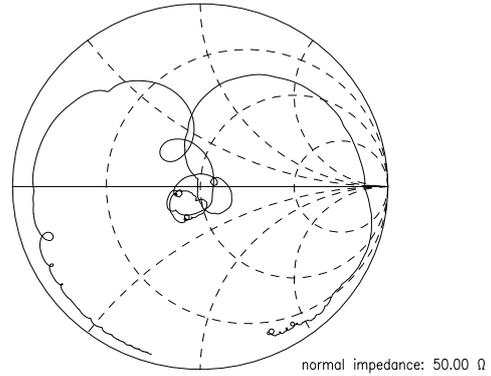
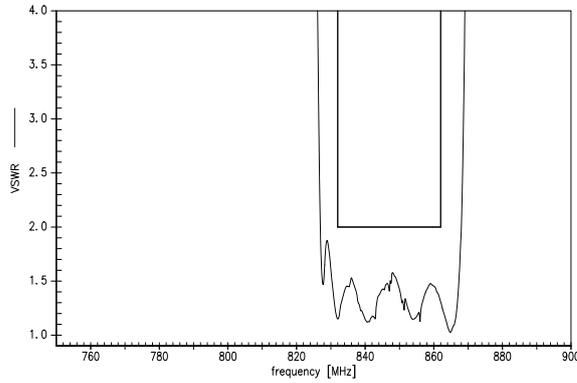
Frequency Response TX-RX (ISOLATION)



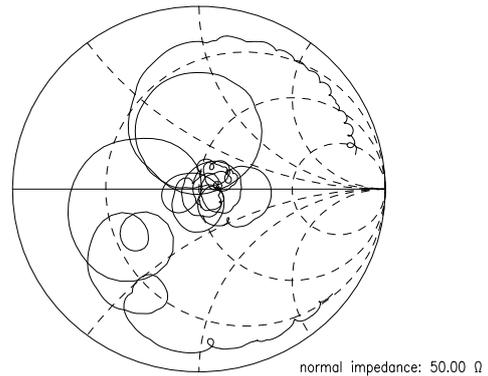
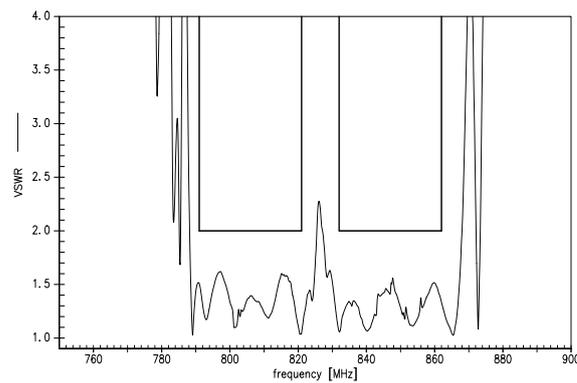
Frequency Response Common Mode Isolation



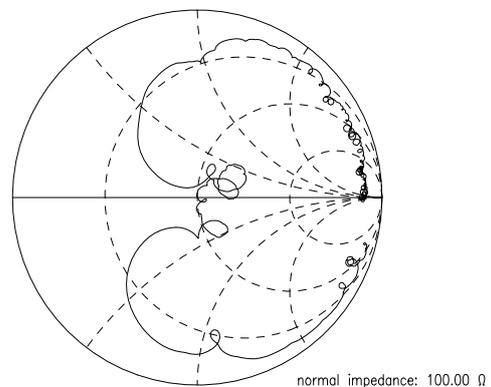
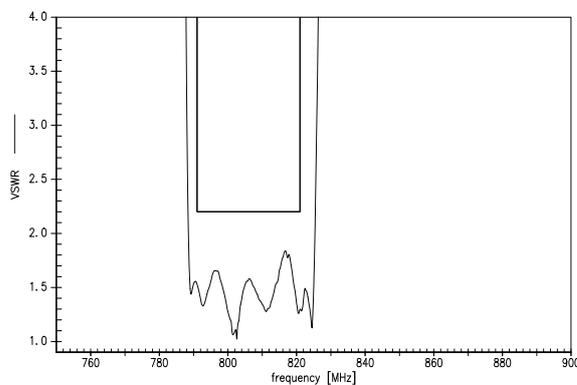
S11 VSWR (TX)



S22 VSWR (ANT)



S33 VSWR (RX)



SAW Components	B8509
SAW Duplexer	847.0 / 806.0 MHz

Data Sheet



References

Type	B8509
Ordering code	B39851B8509P810
Marking and package	C61157-A8-A68
Packaging	F61074-V8259-Z000
Date codes	L_1126
S-parameters	B8509_NB_UN.s4p, B8509_WB_UN.s4p See file header for port/pin assignment table.
Soldering profile	S_6001
RoHS compatible	RoHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8 th , 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.
Moldability	Before using in overmolding environment, please contact your EPCOS sales office.
Matching coils	See Inductor pdf-catalog http://www.tdk.co.jp/tefe02/coil.htm#aname1 and Data Library for circuit simulation http://www.tdk.co.jp/etvcl/index.htm

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